

11-19-2003

Form PTO-1595 (Rev. 10/02)		REC		U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office	
OMB No. 0651-0027 (exp. 6/30/2005)		102604111			
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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.					
1. Name of conveying party(ies): <u>HAN, Seung Hee</u>		2. Name and address of receiving party(ies) Name: <u>HYNIX SEMICONDUCTOR INC.</u>			
Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		Internal Address: _____			
3. Nature of conveyance: <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other _____		Street Address: <u>San 136-1, Ami-ri,</u> <u>Bubal-eub, Ich'on, Kyoungki-do,</u> <u>Republic of Korea</u> City: _____ State: _____ Zip: _____			
Execution Date: <u>October 30, 2003</u>		Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No			
4. Application number(s) or patent number(s):		October 30, 2003			
If this document is being filed together with a new application, the execution date of the application is: _____					
A. Patent Application No.(s) <u>10704895</u>		B. Patent No.(s)			
Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No					
5. Name and address of party to whom correspondence concerning document should be mailed: Name: <u>Richard J. Streit</u> Internal Address: _____ Street Address: <u>c/o Ladas &amp; Parry</u> <u>224 South Michigan Avenue</u> City: <u>Chicago</u> State: <u>IL</u> Zip: <u>60604</u>		6. Total number of applications and patents involved: <u>1</u>			
		7. Total fee (37 CFR 3.41).....\$ <u>40.00</u> <input checked="" type="checkbox"/> Enclosed <input type="checkbox"/> Authorized to be charged to deposit account			
		8. Deposit account number: <u>12-0400</u> (Attach duplicate copy of this page if paying by deposit account)			
<b>DO NOT USE THIS SPACE</b>					
9. Statement and signature. <i>To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.</i> <u>Richard J. Streit</u> Name of Person Signing Reg. 25765 <u>November 10, 2003</u> Signature Date Total number of pages including cover sheet, attachments, and documents: <u>3</u>					

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Mail documents to be recorded with required cover sheet information to:  
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UNITED STATES OF AMERICA  
ASSIGNMENT

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In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

**ASSIGNOR:**

Name : Seung Hee HAN

Address : LP2 Team, System IC, Hynix Semiconductor Inc., Hyangjeong-dong, Heungdeok-gu, Cheongju, Chungcheongbuk-do, Korea

(INVENTOR NAME AND ADDRESS)

hereby sells, assigns and transfers to

**ASSIGNEE:**

Name : Hynix Semiconductor Inc.

Address : San 136-1, Ami-ri, Bubal-eub, Ich'on, Kyungki-do, Korea

(ASSIGNEE NAME AND ADDRESS)

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the invention entitled:

METHOD FOR FORMING METAL WIRING OF SEMICONDUCTOR DEVICE

(TITLE)

and which is found in *(check one applicable item below)*

☒ U.S. patent application executed on even date herewith

☐ U.S. Application Serial No. \_\_\_\_\_ filed on \_\_\_\_\_

and, in and to all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, substitute, reissue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify

as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/we have set our hand and seal

October 30, 2003

Date

*Seung Hee. Han*

INVENTOR: Seung Hee HAN

Date

INVENTOR:

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